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| Project | IEEE 802 Wireless Interim Opening Plenary May 2023 | |
| Title | Meeting Minutes for May 15th, 2023 | |
| Date Submitted | June 19th, 2023 | |
| Source | Stephen McCann  Huawei Technologies Co., Ltd | E-mail: stephen.mccann@ieee.org |
| Re: | Meeting Minutes | |
| Abstract |  | |
| Purpose | Maintain Meeting Record | |
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**Abbreviations:**

A: Answer

C: Comment

Q: Question

**IEEE 802 Wireless Interim Session - Joint Opening Plenary #118**

**May 2023**

**Monday May 15th, 2023, 08:00 Eastern Time (ET)**

1. **Call to order**: Meeting called to order at 08:07 ET

* **Chair**: Dorothy Stanley
* **Recording Secretary**: Stephen McCann
* There was one member of the IEEE staff present (Christy Bahn).
* Attendance in Annex A of this document

1. **Review and approve agenda**

* <https://mentor.ieee.org/802-ec/dcn/23/ec-23-0091-00-WCSG-2023-may-wireless-interim-opening-plenary-agenda.xlsx>
* **Move to approve the agenda:**
  + Moved: Tim Godfrey, 2nd: Mark Hamilton
  + No objection to approving by unanimous consent.
* **Policy and Procedure reminders**
* **<**<http://ieee802.org/sapolicies.shtml>>
* The chair read out the relevant policies and procedures, including the copyright policy.
* No statements were made.
* **Minutes from the last meeting January 2023**:
* <https://mentor.ieee.org/802-ec/dcn/23/ec-23-0013-00-WCSG-minutes-2023-01-wireless-interim-opening-plenary.docx>
* No actions from these minutes
* Consent agenda item. Approved with approval of agenda.

1. **Venue Information and Treasury Status**

* **Treasury Report:**
* <https://mentor.ieee.org/802-ec/dcn/23/ec-23-0003-04-WCSG-wireless-treasurer-report-2023.pptx>
* Note that there are some outstanding assets and deposits.
* There are 520 people attending this session and everyone should have paid registration fees to attend. The general trend is that this number is increasing per session.
* Slide #12 shows the meeting fees for future interim meetings.
* Please remember that a meeting fee is required to attend this meeting and the other meetings this week. There were 2 deadbeats from the March 2023 plenary meeting.
* No questions
* **Future Venue information:**
* This document contains information about this May 2023 session in Orlando, Florida, USA and some future venues:
* <https://mentor.ieee.org/802-ec/dcn/23/ec-23-0001-02-WCSG-ieee-802wcsc-meeting-venue-manager-report-2023.pptx>
* Slide #3 shows the future interim venues.
* A motion was approved in the 802 wireless chairs meeting (Sunday May 14th) to pursue Kobe, Japan as the venue for January 2025.
* Chair: I would like to thank Jon Rosdahl for all the work he puts into assisting with future venues.
* No questions

1. **Reports from WG and SC Chairs**

* **802.11 (Wireless Local Area Network – WLAN)**
* A summary of the recent 802.11 activities was presented in documents:
* 11-23-0618r2 (agenda) & 11-23-0619r0 (opening report)
* Dorothy Stanley presented the documents.
* Slide #12 of document 11-23-0619r0 shows all the current 802.11 activities.
* Projects 11az and 11bd have now finished and those amendments are now published. There will be some awards for these projects during the 802.11 mid-week plenary.
* In November 2023 there will be a new study group about millimeter wave technology.
* There are currently 527 voting members.
* No questions
* **802.15 (Wireless Specialty Networks - WSN)**
* <https://mentor.ieee.org/802.15/dcn/23/15-23-0199-04-0000-may-2023-opening-report-for-802-15.pptx>
* Clint Powell presented the document
* There are currently 133 voting members.
* No questions
* **802.18 (Radio Regulatory Technical Advisory Group)**
* A summary of the recent 802.18 activities was presented in documents:
* <https://mentor.ieee.org/802.18/dcn/23/18-23-0047-02-0000-2023-may-rr-tag-chair-opening-report.pptx>
* Edward Au presented the document.
* The WG is starting some member enrichment activities. This week the topic is an introduction to ETSI and TC BRAN.
* There are currently 50 voting members.
* No questions
* **802.19 (Coexistence)**
* A summary of the recent 802.19 activities was presented in document:
* <https://mentor.ieee.org/802.19/dcn/23/19-23-0009-00-0000-may-2023-wg-opening-report.pptx>
* Steve Shellhammer presented the document.
* There are currently 51 voting members.
* No questions
* **802.24 (Vertical Applications)**
* A summary of the recent 802.24 activities was presented in document:
* <https://mentor.ieee.org/802.24/dcn/23/24-23-0009-02-0000-may-2023-interim-meeting-presentation.pptx>
* Tim Godfrey presented the document.
* There are currently 27 voting members.
* No questions

1. **Discussion Topics**

* None

1. **Other Business**

**802REVc meetings**

* This will occur during the week on Tuesday, Wednesday and Thursday. Please look at the 802.1 schedule. The meetings are also available on the meeting tool.
* 802.1 is meeting this week, but at a different venue.
* Q: What is the context of these meetings please?
* A: IEEE 802 is the master specification for all of the IEEE 802 WGs. It covers how an architecture works, including MAC address structures. This specification needs an update and project 802REVc is doing this work. There is also some editorial work being done.
* For further information, please see document:
* <https://mentor.ieee.org/802.11/dcn/23/11-23-0848-01-0000-802revc-agenda-may-2023.xlsx>

1. **Action items**

* None

1. **Adjourn**

* No objection to adjourning
* Adjourned at 08:56 ET

**Annex A: Attendance & Affiliation (*requires updating*)**

| **Name** | **Affiliation** |
| --- | --- |
| Aboulmagd, Osama | Huawei Technologies Co., Ltd |
| Au, Kwok Shum | Huawei Technologies Co., Ltd |
| Bahn, Christy | IEEE STAFF |
| baron, stephane | Canon Research Centre France |
| Baykas, Tuncer | Ofinno |
| Bims, Harry | Bims Laboratories, Inc. |
| Bluschke, Andreas | Signify |
| Chaplin, Clint | Self |
| Chung, Chulho | SAMSUNG |
| Das, Subir | Perspecta Labs Inc |
| Erkucuk, Serhat | Ofinno |
| Fujimori, Yuki | Canon Research Centre France |
| Goto, Fumihide | DENSO |
| Granhaug, Kristian | Novelda AS |
| Halasz, David | Morse Micro |
| Huang, Nai-Lun | Industrial Technology Research Institute |
| John, Toby | Verizon |
| Kabbinale, Aniruddh | SAMSUNG |
| Kezys, Vytas | HaiLa |
| KOBAYASHI, Takumi | Yokohama National University |
| Kohno, Ryuji | YNU; YRP-IAI |
| Krieger, Ann | US Department of Defense |
| Lalam, Massinissa | SAGEMCOM BROADBAND SAS |
| Lee, Nancy | Signify |
| Levy, Joseph | InterDigital, Inc. |
| Li, Huan-Bang | NICT |
| McCann, Stephen | Huawei Technologies Co., Ltd |
| Montreuil, Leo | Broadcom Corporation |
| Orlik, Philip | Mitsubishi Electric Corporation |
| Petrick, Albert | Skyworks Solutions Inc. |
| Prabhakaran, Dinakar | Broadcom Corporation |
| Quan, Yingqiao | Unisoc |
| Rajashekar, Rakshith | Broadcom Corporation |
| Riegel, Maximilian | Nokia |
| Rosdahl, Jon | Qualcomm Incorporated |
| Sakaguchi, Naotaka | Mitsubishi Electric Corporation |
| Sand, Stephan | German Aerospace Center (DLR) |
| Scott, Andy | NCTA |
| Serizawa, Kazunobu | Advanced Telecommunications Research Institute International (ATR) |
| Shellhammer, Stephen | Qualcomm Incorporated |
| Shen, Andy | Futurewei Technologies |
| Stacey, Robert | Intel |
| Stanley, Dorothy | Hewlett Packard Enterprise |
| Stuebing, Gary | Cisco Systems, Inc. |
| Sumi, Takenori | Mitsubishi Electric Corporation |
| Taori, Rakesh | Infineon Technologies |
| VIGER, Pascal | Canon Research Centre France |
| Wu, Kanke | Qualcomm Incorporated |
| Yang, Lin | Qualcomm Incorporated |
| Yano, Kazuto | Advanced Telecommunications Research Institute International (ATR) |
| Zakaib, Larry | Spark Microsystems |
| Zhou, Lei | H3C Technologies Co., Limited |

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